

BGF111

TV-Out Filter and ESD Protection

Small Signal Discretes



Never stop thinking

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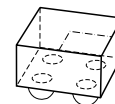
BGF111**Revision History: 2008-05-28, V2.0****Previous Version: 2007-04-26**

Page	Subjects (major changes since last revision)
All	Preliminary status removed

BGF111

Features

- TV-Out Filter
- Wafer level package with SnAgCu solder balls
- Integrated ESD protection up to 15 kV contact discharge according to IEC61000-4-2
- Low bias voltage dependency of low pass frequency
- RoHS and WEEE compliant package



WLP-4-1-3D



Description

BGF111 is a 75 Ω TV-Out filter with low pass characteristic offering a high stop band attenuation up to 6 GHz in mobile phone, consumer and IT applications. Wafer technology is optimized to provide low variation of the low pass frequency versus bias voltage. ESD protection at both pins exceeds 15 kV contact discharge according to IEC61000-4-2. The wafer level package is a green leadfree package with a size of only 0.75 mm x 0.75 mm and a total height of 0.6 mm.

Type	Package	Marking	Chip
BGF111	WLP-4-1	11	N0724

Table 1 Maximum Ratings

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Voltage at all pins to GND		0	–	5	V	–
Operating temperature range	T_{OP}	-40	–	85	°C	–
Storage temperature range	T_{STG}	-65	–	150	°C	–
DC current A1 to B1	I_{max}	–	–	35	mA	–

Electrostatic Discharge According to IEC61000-4-2

Contact discharge between all pins	V_{ESD}	-15	–	+15	kV	–
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Table 2 Electrical characteristics at $T_A = 25^\circ\text{C}$

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Resistor R1	R_1	71.25	75	78.75		–
Leakage currents, A1 or B1 to GND	I_R	–	0.1	120	nA	$V_R = \pm 3 \text{ V}$
		–	0.1	120	μA	$V_R = \pm 14 \text{ V}$
Line capacitance to GND	C_L	–	44	–	pF	$V = 0 \text{ V}$
Insertion loss at 0 V bias voltage Pin A1 to B1	IL	–	30	–	dB	$f = 0.8 \dots 2 \text{ GHz}$, $Z_S = Z_L = 75 \Omega$

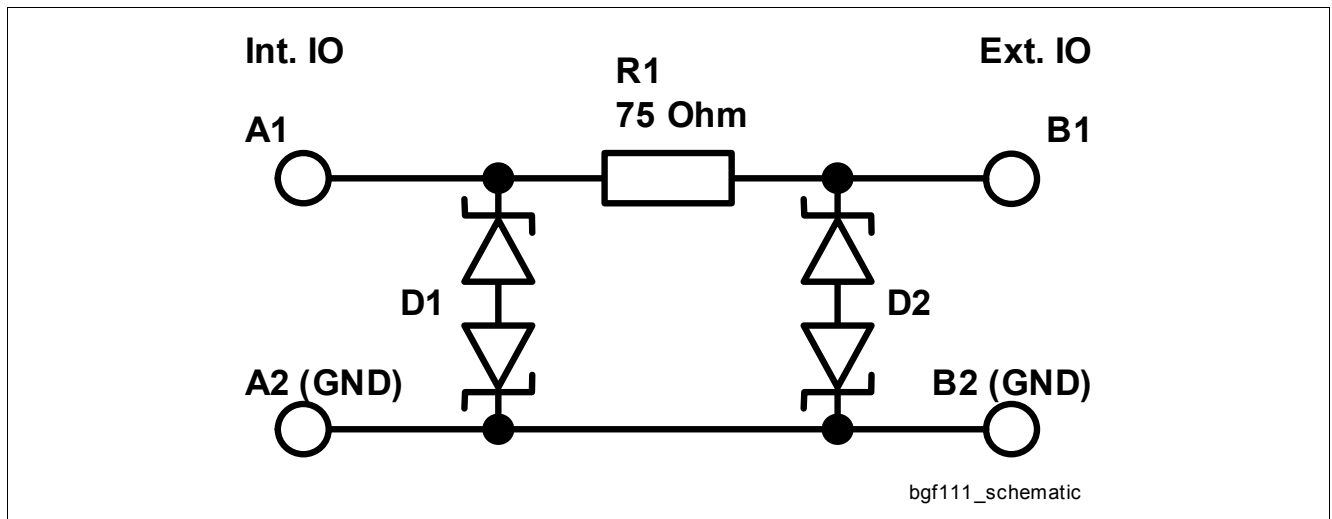


Figure 1 Schematic

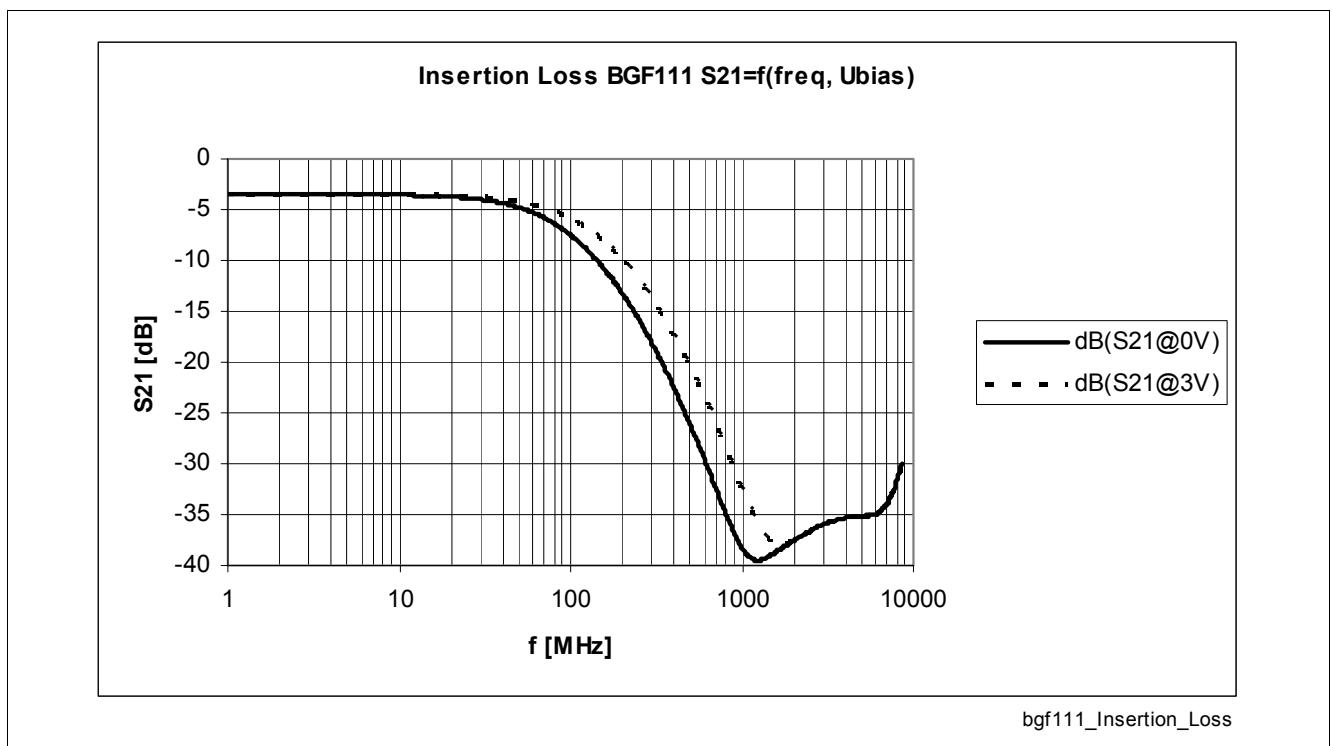


Figure 2 Insertion loss as function of bias voltage, $Z_S = Z_L = 75 \Omega$

Package Outline

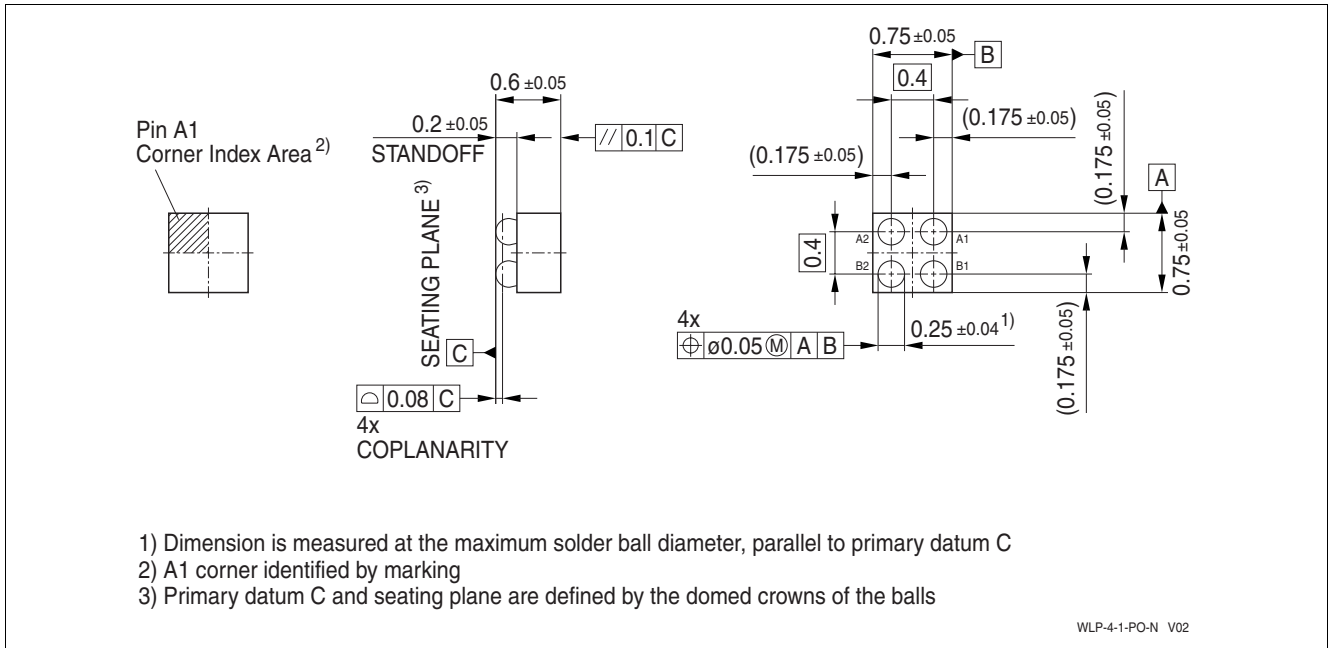


Figure 3 Package outline

Tape for BGF111

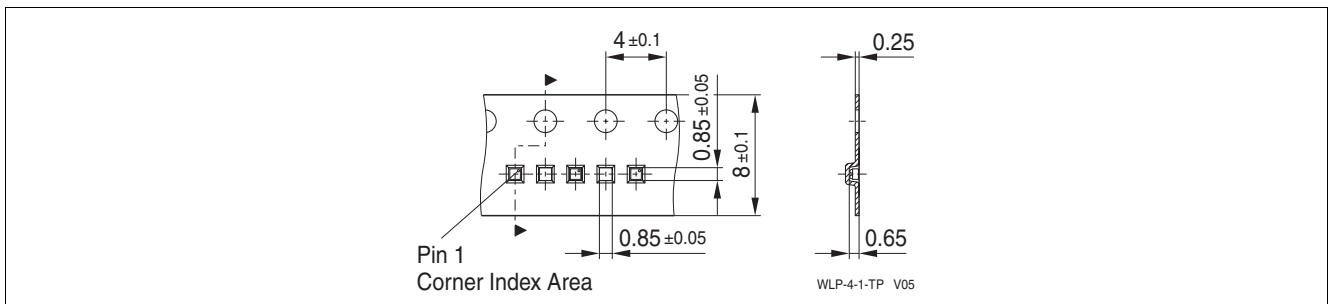


Figure 4 Tape for BGF111 / WLP-4-1

You can find all of our packages, sorts of packing and others in our Infineon Internet Page "Products":
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